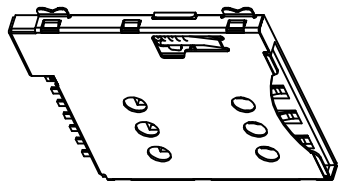
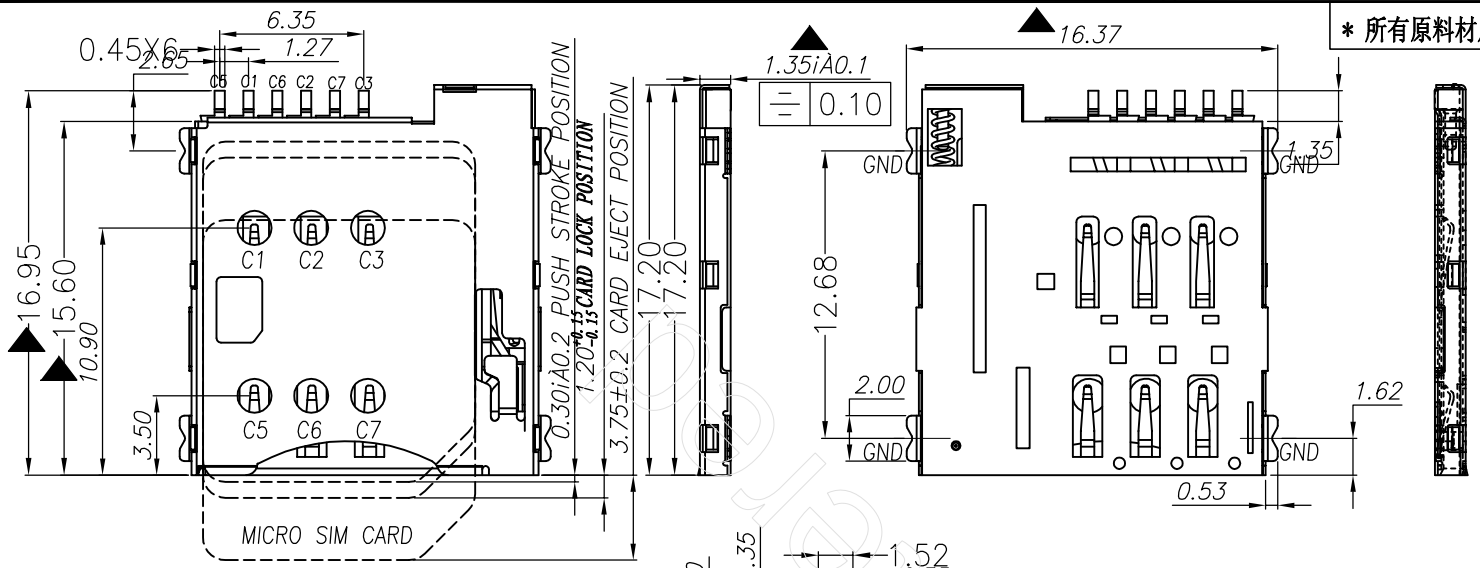
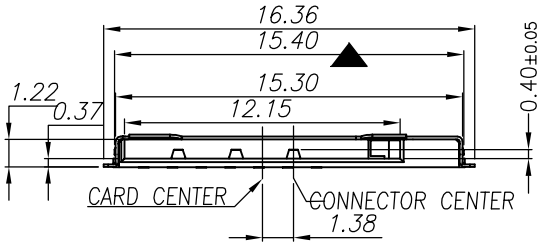
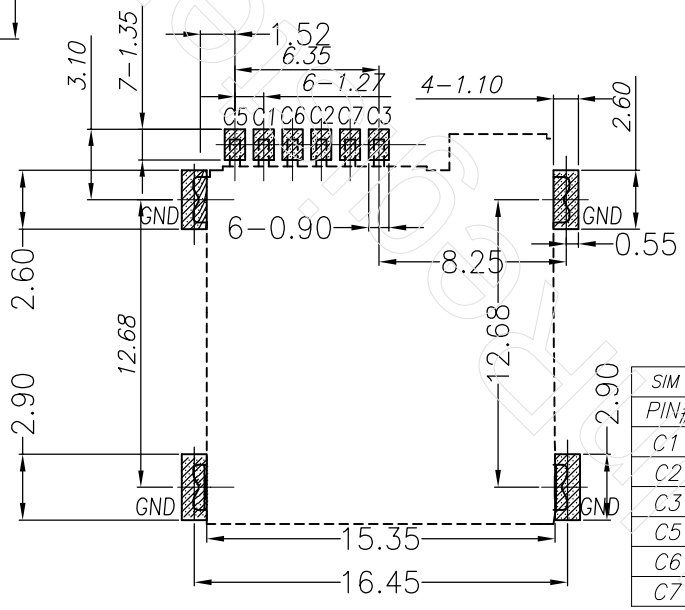
由 Autodesk 教育版产品制作

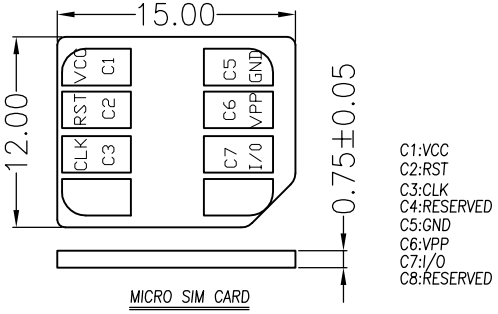
* 所有原料材质,生产制程,电镀必须符合ROHS要求






C1:VCC
C2:RST
C3:CLK
C4:RESERVED
C5:GND
C6:VPP
C7:I/O
C8:RESERVED

PCB 焊盘区

下沉避位区

RECOMMENDED PCB LAYOUT

GENERAL TOLERANCE ±0.05

| SIM pin assignment | |
|---|---|
| PIN# | Name |
| C1 | VCC供电电压 |
| C2 | RST重置 |
| C3 | CLK时钟 |
| C5 | GND接地 |
| C6 | VPP程序电压 |
| C7 | I/O输入输出 |

## Specification

**MATERIAL:**

Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy
Shell: SUS

**PLATING:**

Contact: Plated 50u'' Ni Overall Contact Au 1U
Shell: Plated 50u'' Ni Overall
Plated 1u"Au Selective Contact Area

**Electrical:**

Current Rating :0.5mA AC/DC max.
Voltage Rating :125V AC/DC
Ambient Temperature Range :-20° C~+60° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100m max. Ω
Insulation Resistance:1000M min./500VDC Ω
Mating Cycles:10,000 Insertions
产品耐温温度：260° C □C S≤1.70×□C S≤1.70×5□C -5□C
Mating Cycles:3,000-5,000 Insertions

| REVISION NO. | ECR NO. | DESCRIPTION | MARK | DATE |
|---|---|---|---|---|
| | | | | |

DIMENSIONS INIT: mm
UNLESS OTHERWISE SPECIFIABLE

| DIMENSION | TOLERANCE |
|---|---|
| X.X: ± | 0.15 |
| X.XX: ± | 0.10 |
| X.XXX: ± | 0.05 |
| ANGULAR: ± | 1° |

# 浙江创都电子科技有限公司

| | | |
|---|---|---|
| PRODUCT NAME : MICRO-SIM 卡座PUSH/PUSH 1.35H-6 PIN X | DRAWING: | DATE: 2012/04/10 |
| PART NO: CAX-MICRO-SIM-ZT6PAU-Z | CHECK: | DATE: 2012/04/11 |
| 模号：Z | APPROVED: | DATE: 2012/04/11 |
| | SCALE: 1:1 / DWG ID: C D / REV.: B | PAGE: 1 OF 1 |

由 Autodesk 教育版产品制作